

Bandpass Filter

BFHKI-1982+

50Ω 17.5 to 22.2 GHz

THE BIG DEAL

- · LTCC Band Pass Filter with Integrated Interposer Board
- Wide Stopband Rejection, Typ. 35 dB up to 46.5 GHz
- Small Size, 4.95x3.65 mm
- Shielded Construction
- Protected by US Patents 11,638,370 and 11,744,057



Generic photo used for illustration purposes only

FUNCTIONAL DIAGRAM

RF1 RF2

APPLICATIONS

Test & Measurement Equipment

PRODUCT OVERVIEW

BFHKI-1982+ is a miniature low temperature co-fired ceramic (LTCC) ultra-high stopband rejection band pass filter with a 17.5 to 22.2 GHz passband supporting a variety of applications. This model achieves 35 dB typical stopband rejection up to 46.5 GHz, when mounted on coplanar waveguide layouts. Housed in a small 4.95 mm by 3.65 mm ceramic form factor, the filter is ideal for dense signal chain PCB layouts where it complements MMIC size and performance. The BFHKI family with integrated interposer board enables installation onto PCB layouts with automated manufacturing equipment. This model provides low insertion loss of typically 3.4 dB from 17.5-21 GHz and 4.3 dB from 21-22.2 GHz due to its rugged monolithic construction. The LTCC fabrication process assures minimal RF performance variation while delivering a product that is well suited for environmental extremes of high humidity and temperature.

KEY FEATURES

Features	Advantages
Surface Mountable Due to Integrated Interposer Board	Enables installation with automated manufacturing equipment making this suitable for high-volume processes.
Wide Rejection	Provides high stopband rejection of 35 dB typical up to 46.5 GHz.
Small Size (4.95x3.65 mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Wide Operating and Storage Temperature, -55 to 125°C	Enables use in high reliability and extreme environment condition such as aerospace & defense applications.
Cost Effective	LTCC is a scalable technology that is cost effective due to ease of production in high-volume

REV. OR ECO-018272 BFHKI-1982+ MCL NY 250717



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ELECTRICAL SPECIFICATIONS^{1,2,3} AT +25°C

Parameter		F#	Frequency (GHz)	Min.	Тур.	Max.	Units
	Center Frequency ⁴				19.85		GHz
Passband	Incortion Loss	F2-F3	17.5 - 21		3.4	4.5	dB
Passband	Insertion Loss		21 - 22.2		4.3	4.9	dB
	Return Loss	F2-F3	17.5 - 22.2		8		dB
Stankand Lauren	Rejection	DC-F1	0.1 - 11	55	65		dB
Stopband, Lower			11 - 12.6	40	50		ав
			27.5 - 29	30	50		
Stopband, Upper	Rejection	F4-F5	29 - 37.5	25	45		dB
			37.5 - 46.5		35		

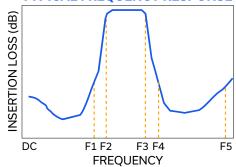
^{1.} Tested on Evaluation Board P/N TB-BFHKI-1982C+. Measured with the connector and feedline effects de-embedded using the 2XThru IEEE P370 method.

ABSOLUTE MAXIMUM RATINGS⁵

Parameter	Ratings
Operating Temperature	-55 °C to +125 °C
Storage Temperature	-55 °C to +125 °C
Input Power ⁶	1 W

^{5.} Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



^{2.} Bi-directional RF1 and RF2 ports can be interchanged.

^{3.} This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

^{4.} Typical variation ± 5%.

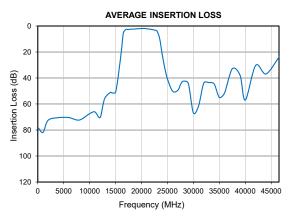
^{6.} Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.5 W at +125°C.

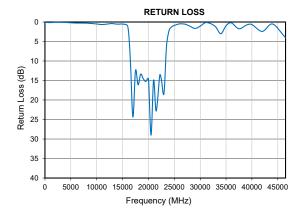
Bandpass Filter

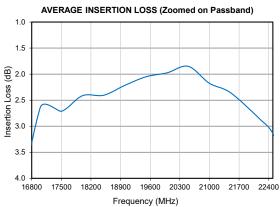
BFHKI-1982+

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TYPICAL PERFORMANCE GRAPHS







Bandpass Filter

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FUNCTIONAL DIAGRAM

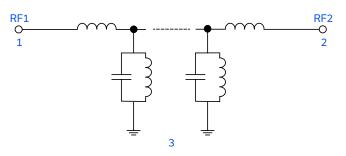
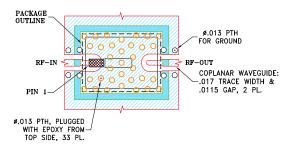


Figure 1. BFHKI-1982+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description			
RF1 ^(Note 2)	1	Connects to RF Input Port			
RF2 ^(Note 2)	2	Connects to RF Output Port			
GROUND	3	Connects to Ground on PCB, (See drawing PL-753)			

SUGGESTED PCB LAYOUT (PL-753)



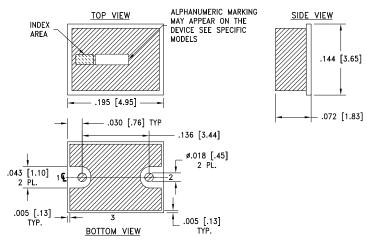
NOTES:

- 1. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B
 WITH DIELECTRIC THICKNESS .010"; COPPER: 1/2 OZ.
 FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB ARE CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER) DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Figure 2. Suggested PCB Layout for BFHKI-1982+

CASE STYLE DRAWING



METALLIZATION

Weight: .135 grams.

Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.005

PRODUCT MARKING*: F471

*Marking may contain other features or characters for internal lot control.



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ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASHBOARD.

CLICK HERE

	D.J.				
	Data				
Performance Data & Graphs	Graphs				
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads				
Case Style	NM3237 Finish: Gold over Nickel Plating				
RoHS Status	Compliant				
Tape and Reel	TR-F77				
Suggested Layout for PCB Design	PL-753				
Evaluation Board	TB-BFHKI-1982C+				
Evaluation Doalu	Gerber File				
Environmental Rating	ENV06T12				

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

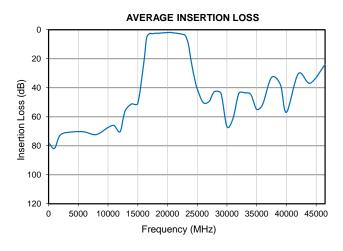


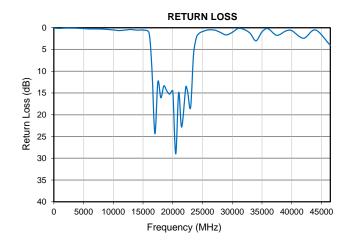
LTCC Bandpass Filter BFHKI-1982+ Typical Performance Data

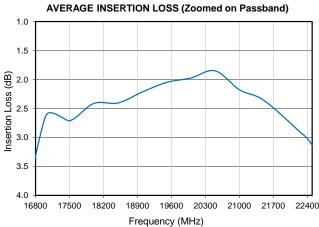
FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
100	78.37	0.10
1000	81.83	0.16
2000	72.46	0.08
4000	70.49	0.12
6000	70.43	0.27
8000	72.32	0.29
10000	67.40	0.51
11000	66.06	0.65
12000	70.45	0.53
12600	60.09	0.44
13000	54.98	0.40
14000	51.09	0.55
15000	50.78	0.54
16000	23.18	1.13
16500	5.28	9.56
17000	2.65	24.35
17500	2.71	12.45
18000	2.41	16.10
18500	2.41	13.37
19000	2.22	14.53
19500	2.05	15.26
20000	1.97	14.52
20500	1.85	29.00
21000	2.18	14.90
21500	2.36	22.84
22200	2.87	13.59
22500	3.14	14.67
23000	4.04	18.34
23500	9.80	6.09
24000	22.18	2.14
24500	32.63	1.24
25000	40.78	0.88
26000	50.19	0.48
27000	49.45	0.54
27500	45.15	0.76
28000	42.48	1.07
29000	43.99	1.65
30000	66.83	1.07
31000	61.41	0.17
32000	43.88	0.40
33000	43.55	1.26
34000	44.58	3.00
35000	54.92	0.96
36000	51.50	0.21
37500	32.88	1.74
39000	37.99	0.75
40000	56.97	0.66
42000	30.33	2.41
44000	36.87	0.51
46500	23.89	4.04



Typical Performance Data



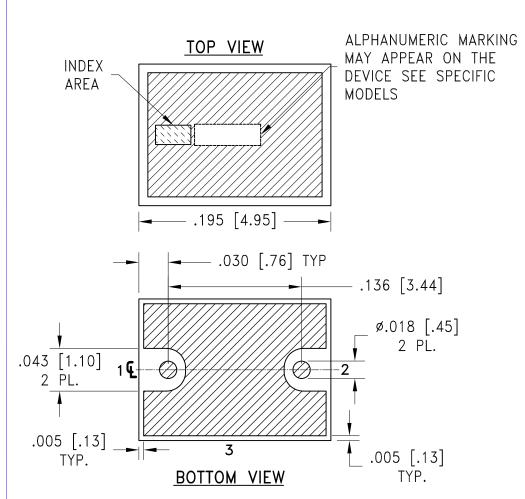


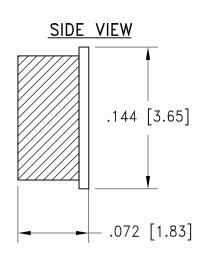


NM

Outline Dimensions

NM3237







Weight: .135 grams.

Dimensions are in inches (mm). Tolerances: 2 Pl.±.01; 3 Pl. ±.005

Notes:

1. Case material: LTCC on printed circut board base.

2. Termination Finish: as shown below or indicated on Data Sheet.
For RoHS Case Styles: Gold Plate over Nickel plate. All models, (+) suffix.



INTERNET http://www.minicircuits.com

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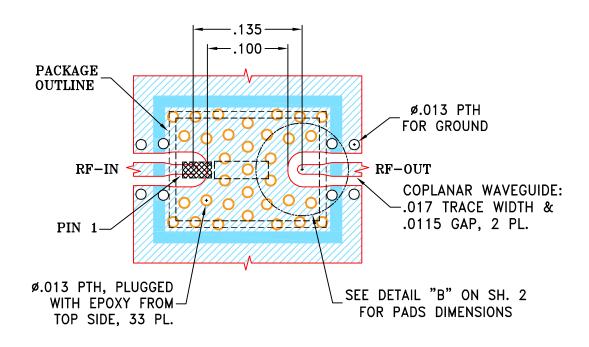
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THIRD ANGLE PROJECTION

	REVISIONS							
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH			
OR	ECO-017025	NEW RELEASE	03/30/23	ITG	IL			
OR1	ECO-018201	CORRECTED TYPO IN NOTE 2	06/16/23	ITG	IL			
A	ECO-020890	ADDED DETAIL "A" (SH.2) & DIMENSIONS	02/16/24	ITG	IL			

SUGGESTED MOUNTING CONFIGURATION FOR NM3237 CASE STYLE



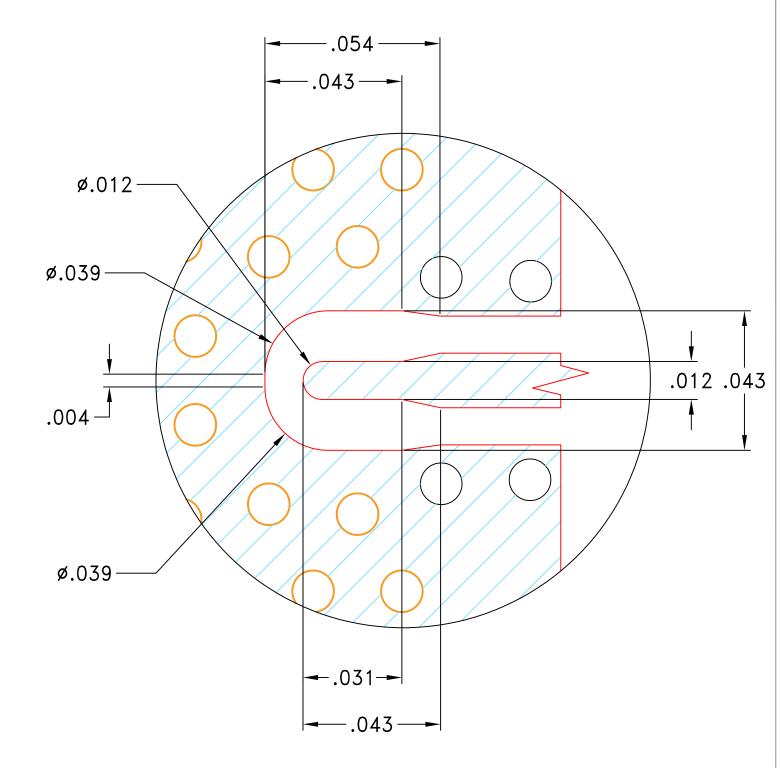
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- 2. BOTTOM SIDE OF THE PCB ARE CONTINUOUS GROUND PLANE.

ASHEETA1.DWG REV:A DATE:01/12/95

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

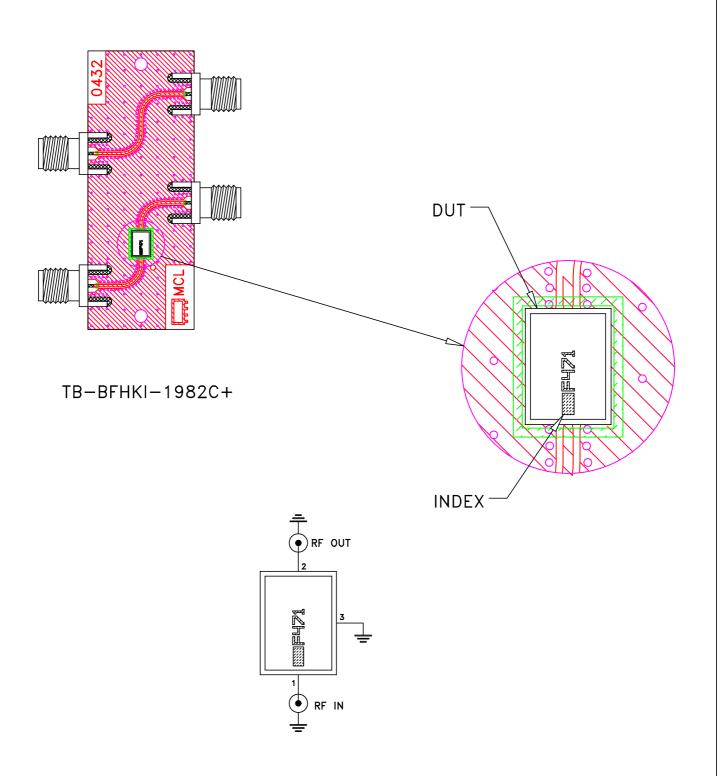
DE	NOTES (COPPER LA	AND PATTE	RN FRE	E OF SOLDE	R MASK					
UNLESS OTHERWISE SPECIFIED		INITIALS	DATE			. ~:		• 4 R			
DIMENSIONS ARE IN INCHES	DRAWN	ITG	03/30/23		\sqcup Mini	i-Cir	'cu	1ts 13.1	Neptu	ne Aver NY 112	nue
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	GF	03/30/23		Τ			Broc	окіуп	NI 114	೭35
3 PL DECIMALS ± .005 ANGLES ±	APPROVED	IL	03/30/23								
FRACTIONS ±					PL.	NM323	37. ^r	$\Gamma B - 120$	00		
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DETAIL "A". SOLDER MASK IS NOT SHOWN FOR CLARITY

(SCALE 4:1)

Evaluation Board and Circuit



Schematic Diagram

Notes:

- 1. SMA Female connectors.
- 2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.010 inch.

III Mini-Circuits®



ENV06T12



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Thermal Cycling	-55 to 125°C, 100 cycles, Dwell Time 15 minutes.	MIL-STD-202, Method 107, Condition A-3
Humidity	85°C, 90-95% Relative Humidity, 250hours	
Solderability	10X / 30X Magnification	J-STD-002C Test S, J-STD-002C Test S1
High Temp Storage	125°C, 250 hours	
Bend Test	1mm, deflection for 5 seconds Span of bending: 2.75"	

ENV06T12Rev: OR

06/27/23

DCO-1237 File: ENV06T12.pdf